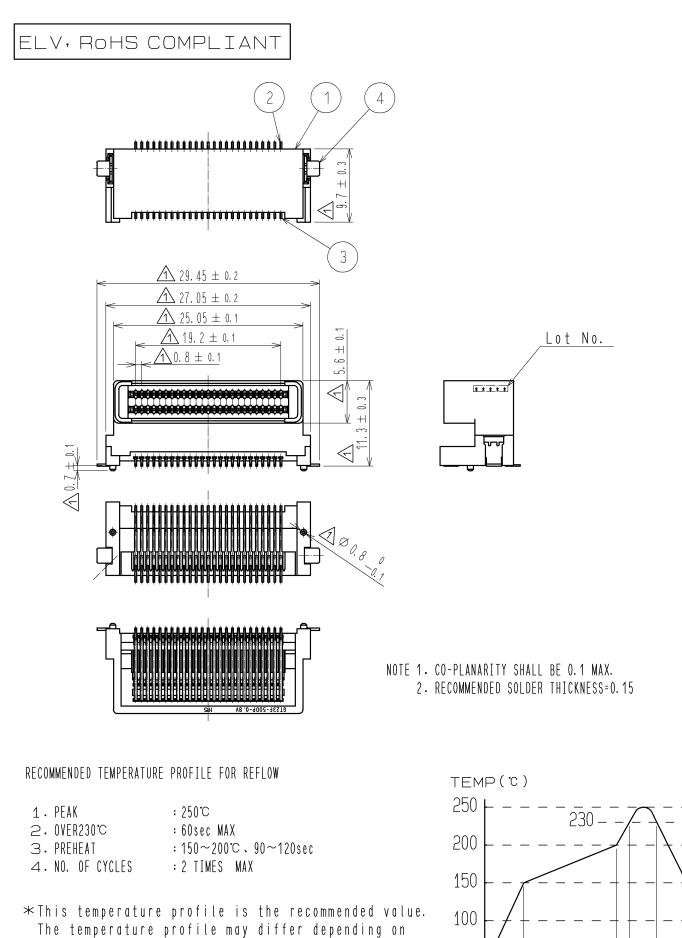
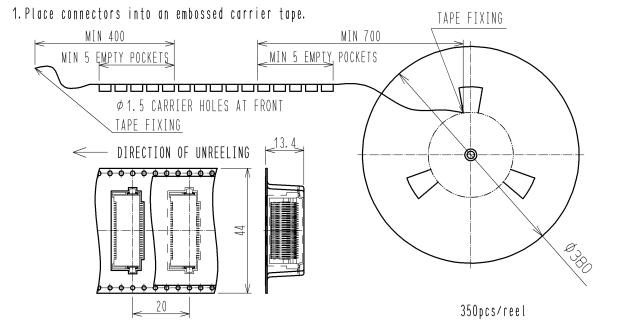
APPLICAI	BL	E STANDAF	RD										
RATING	OPERATING TEMPERATURE RANGE			1 10 10 10 10 10 NOTEN			RAGE IPERATL	IRE RANGE		-40 °C TO +105 °C			
VOLTAGE				50 V AC	RRENT			0.5 A					
				SPECIF	FICAT	IONS	3						
	ITE	EM		TEST METHOD				RE	QUI	REMENTS	QT	AT	
CONSTRU	UC	TION											
GENERAL EXAMINATION			VISUAL	LY AND BY MEASURING IN	ACCO	ACCORDING TO DRAWING.							
MARKING			CONFIR	RMED VISUALLY.					Х	Х			
		CHARACTER	RISTICS										
CONTACT RESISTANCE			0.5A DC	·				100 mΩ MAX.					
CONTACT RESISTANCE			20 mV A	AC MAX, 0.1 mA(DC OR 10	00Hz)			X	_				
MILLIVOLT LEVEL METHOD INSULATION RESISTANCE			250 V D	С				X	-				
VOLTAGE PROOF			250 V A	C FOR 1 min.			NO FL	X	_				
MECHANI	IC/	AL CHARAC	TERIST	ICS									
MECHANICAL OPERATION				S INSERTIONS AND EXTRA	<ol> <li>CONTACT RESISTANCE: 120 mΩ MAX.</li> <li>NO DAMAGE, CRACK AND LOOSENESS OF PARTS.</li> </ol>					_			
VIBRATION				ENCY 20 TO 400 Hz, 5 <sup>2</sup> AT 3 h FOR 3 DIRECT	<ol> <li>NO ELECTRICAL DISCONTINUITY OF 10 μs.</li> <li>CONTACT RESISTANCE: 120 mΩ MAX.</li> <li>NO DAMAGE, CRACK AND LOOSENESS OF PARTS.</li> </ol>					_			
SHOCK				ENCY 20 TO 50 Hz, 5 <sup>2</sup> AT 1 h .	<ol> <li>NO ELECTRICAL DISCONTINUITY OF 10 μs.</li> <li>CONTACT RESISTANCE:120 mΩ MAX.</li> <li>NO DAMAGE, CRACK AND LOOSENESS OF PARTS.</li> </ol>					_			
LOCK STRENGTH			APPLYII AT -N MA	NG A PULL FORCE THE MA AX.	DURING APPLYING, MATING COMPLETELY.     AFTER APPLYING, NO DEFECT OF     MATING PARTS.					_			
ENVIRON	ME	ENTAL CHAP	RACTER	RISTICS									
DAMP HEAT (STEADY STATE)		EXPOSE	DAT 60°C, 90 ~ 95%,	<ol> <li>CONTACT RESISTANCE: 120 mΩ MAX.</li> <li>INSULATION RESISTANCE:100 MΩ MIN.</li> <li>NO DAMAGE, CRACK AND LOOSENESS OF PARTS.</li> </ol>					_				
RAPID CHAN	NGE	E OF	TEMPER	ATURE-40→5 TO 35→ 80−	① CO								
TEMPERATURE			TIME UNDER	$30 \rightarrow 5 \rightarrow 30$ 1000 CYCLES.	<ul> <li>(2) INSULATION RESISTANCE:100 MΩ MIN.</li> <li>(3) NO DAMAGE, CRACK AND LOOSENESS OF PARTS.</li> </ul>					_			
DRY HEAT			EXPOSE	D AT 105°C, 300 h.	<ol> <li>CONTACT RESISTANCE: 120 mΩ MAX.</li> <li>NO DAMAGE, CRACK AND LOOSENESS OF PARTS.</li> </ol>					_			
COLD			EXPOSE	D AT -40°C , 120 h.	<ol> <li>CONTACT RESISTANCE: 120 mΩ MAX.</li> <li>NO DAMAGE, CRACK AND LOOSENESS OF PARTS.</li> </ol>					_			
RESISTANCE TO HSO <sup>3</sup> GAS			EXPOSE	D IN 500 PPM FOR 8h.	① CO ② NO	Х	-						
RESISTANCE TO SOLDERING HEAT			SOLDER DURATIO	TEMPERATURE, 260°C FC DN, 10 s.	NO DE LOOSE	Х	_						
SOLDERABILITY				ED AT SOLDER TEMPERAT TERSION DURATION, 3 s.	A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.					_			
COUN	1T	DES	CRIPTION	OF REVISIONS		DESIG	SNED			CHECKED	DA	ΤE	
$\triangle$													
REMARK (NOTE1) INCLUDE THE TEMPERATURE RISIN				BY CURRENT.		APPROVE CHECKE DESIGNE		AR. SHIRAI TY. TAKAHASHI TY. SAKASHITA	10. 0 10. 0	3. 29			
					DRAWN			KT. MATSUDA	10.0				
Note QT:Qualification Test A			Γ:Assuran	ce Test X:Applicable Test	DI	DRAWING NO.			ELC4-167667				
RS SPECIFIC				ATION SHEET	PART	RT NO.			GT23F-50DP-0.8H				
HIRO			SE ELE	ECTRIC CO., LTD.		CODE	DE NO. C		773	$\wedge$	1/1		

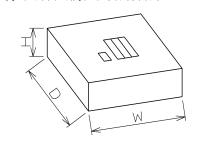


3 ± 0.05 Recommended PCB layout 0.05 5 MAX  $3.2 \pm 0.05$ P=0.8 ± 0.05  $19.2 \pm 0.05$  $0.5 \pm 0.05$  $25.25 \pm 0.05$  $27.45 \pm 0.05$  $\Delta(4:1)$ 

## ⚠ PACKING STYLE



2. Put a reel into a cardboard.



W = (405) (mm)D = (405) (mm)H=(49) (mm)

	2	BRA	SS		Contact:	GOLD	PLATING.	Mounting:TIN PLA	TING 4	BRAS	SS		TIN	PLATING			H
	1 PA				BLAC	K			3	BRAS	SS		Contac	t:GOLD PLATING.	Mounti	ng:TIN PLATING	
	NO.		MATERIAL		F	= I N I	SH ,	REMARKS	NO	.	M A <sup>-</sup>	TERIAL		FINISH , REMA		ARKS	
ſ	UNITS mm		ф <sub>П</sub>		CALE COUNT		DESCRIPTION OF		F REVISIONS		DESIGNED		CHECKED		DATE		
			$\oplus \Box$	7 🖵   2	: 1	$\triangle$	11	DIS-T-00	1896			HH. TSUKUMO		TY. TAKAHAS	SH I	10. 09. 30	F
					APPRO	/ED :	AR. SHI	RAI	10. 03. 29	DRAWIN NO.	G	EC	C3-	167667	-00		
-	L	3 C	■ HIROSE		CHECKE	ED :	TY. TAK	AHASHI	10.03.29	DADT			T ^ ^		^ ^	N 1 1	ĺ

HS ELECTRIC CO..LTD.

10. 03. 29 PAR1 GT23F-50DP-0.8H DESIGNED : TY. SAKASHITA 10. 03. 29 CODE NO. : KT. MATSUDA CL773-0008-0-00 DRAWN

FORM HC0011-5-7 1

recommended temperature profile.

the cream solder, the manufacturer, the PC Board

size, and other mounting materials, etc. Please confirm the mounting condition before applying the

90~120s

60sMAX

TIME(s)